10718534

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|   |            |   |                              |                 | lamed l                   | nventor   | Jack               | D. Burton  |  |   |    |  |
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| ( Not for submission under 37 CFR 1.99)   |            |   |                              |                 | Examiner Name Br          |   |                    | dley Duffy   |  |   |    |  |
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## Application Number 10718534 Filing Date 2003-11-24 INFORMATION DISCLOSURE First Named Inventor Jack D. Burton STATEMENT BY APPLICANT Art Unit 1643 ( Not for submission under 37 CFR 1.99) **Examiner Name Bradley Duffy** 77957-330651 Attorney Docket Number Fung et al., Co-Internalization of the p55 and p70 Subunits of the High-Affinity Human Interleukin 2 Receptor, J. Exp. /BD/ Med. 1988, 168:1923-8. If you wish to add additional non-patent literature document citation information please click the Add button **EXAMINER SIGNATURE Date Considered Examiner Signature** /Brad Duffy/ 03/14/2007 \*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through a citation if not in conformance and not considered. Include copy of this form with next communication to applicant. 1 See Kind Codes of USPTO Patent Documents at www.USPTO.GOV or MPEP 901.04. 2 Enter office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>3</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document.

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